

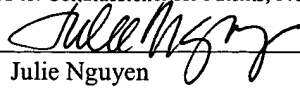
PATENT  
Docket No.: 1125/204

**CERTIFICATE OF MAILING BY "EXPRESS MAIL"**

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Date of Deposit: July 15, 2003

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Julie Nguyen

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In the application of:

Barnoski, et al.

Serial No.: Not Yet Assigned

Filing Date: July 15, 2003

For: STAMPING SYSTEM FOR  
MANUFACTURING HIGH  
TOLERANCE PARTS

Examiner: Not Yet Assigned

Group Art Unit: Not Yet Assigned

**INFORMATION DISCLOSURE  
STATEMENT UNDER 37 C.F.R. § 1.97**

Mail Stop Patent Application  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Pursuant to 37 C.F.R. § 1.97 and § 1.98, applicants submit for consideration in the above-identified application the documents listed on the attached Form PTO-1449. Copies of the documents are also submitted herewith. The Examiner is requested to make these documents of record.

This Information Disclosure Statement is submitted:

- ☒ Within three months of the application filing date or before receipt of a first Office Action on the merits; accordingly, no fee or separate requirements are required.
- ☐ After receipt of a first Office Action on the merits but before a final Office Action or Notice of Allowance.
  - ☐ A fee is required. A check for payment of the fees set forth in 37 C.F.R. § 1.17(p) is attached.
  - ☐ A Certification under 37 C.F.R. § 1.97(e) is provided below; accordingly, no fee is believed to be due.
- ☐ After receipt of a final Office Action or Notice of Allowance, but before payment of the issue fee. A check for payment of the fees set forth in 37 C.F.R. § 1.17(p), and a Certification under 37 C.F.R. § 1.97(e) are provided herein.

The undersigned declares that:

- ☐ Each item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement.
- ☐ No item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the statement after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in § 1.56(c) more than three months prior to the filing of the information disclosure statement.

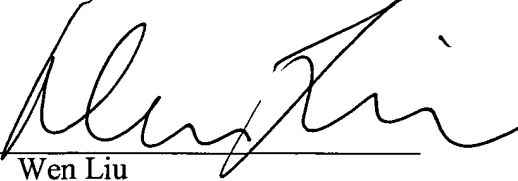
The Assistant Commissioner is hereby authorized to charge any fees which may be required by this statement to **Deposit Account Number 501288** referencing docket no. 1125/204.

Applicants would appreciate the Examiner initialing and returning the Form PTO-1449, indicating that the information has been considered and made of record herein.

This Information Disclosure Statement under 37 C.F.R. § 1.97 is not to be construed as a representation that: (i) a complete search has been made; (ii) additional information material to the examination of this application does not exist; (iii) the information, protocols, results and the like reported by third parties are accurate or enabling; or (iv) the above information constitutes prior art to the subject invention.

Dated: July 15, 2003

Respectfully submitted,

By:   
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**OTHER PRIOR ART**

| Examiner<br>Initials | Ref.<br>No. | Title  |
|----------------------|-------------|--|
|                      | 1. ✓        | “Uni-Guide ® Die System FAQ’s” by Humdinger, Inc., pp. 1 – 5.  |
|                      | 2. ✓        | “Uni-Guide Die System, Patent Pending”, Technical Discussion by Humdinger, Inc., pp. 1 – 6.  |
|                      | 3. ✓        | “Tech Trends, Round Die Set Works with Worn Presses”, <a href="http://www.sme.org/forming&amp;fabricating">www.sme.org/forming&amp;fabricating</a> - /4/2000, p. 18. |
|                      | 4. ✓        | “A New Design for Die Sets”, <a href="http://www.metalforming.com">www.metalforming.com</a> , August 2000, p. 66.  |
|                      | 5.          | “The Uni-Guide Die System”, <a href="http://www.uni-guide.com">www.uni-guide.com</a> , Uni-Guide Products Brochure, pp. 1 – 4.                                       |

|                       |  |                 |  |
|-----------------------|--|-----------------|--|
| Examiner<br>Signature |  | Date Considered |  |
|-----------------------|--|-----------------|--|

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|--|---|----|---|--------------------------|------------------|
| <b>INFORMATION DISCLOSURE<br/>STATEMENT BY APPLICANT</b><br><br><i>(use as many sheets as necessary)</i> |   |    |   | <b>Complete if Known</b> |                  |
|  |   |    |   | Application Number       | Not Yet Assigned |
|  |   |    |   | Filing Date              | July 15, 2003    |
|  |   |    |   | First Named Inventor     | Barnoski, et al. |
|  |   |    |   | Group Art Unit           | Not Yet Assigned |
|  |   |    |   | Examiner Name            | Not Yet Assigned |
| Sheet  | 1 | of | 1 | Attorney Docket Number   | 1125/204         |

| U.S. PATENT DOCUMENTS |          |                          |   |  |  |
|-----------------------|----------|--------------------------|---|--|--|
| Examiner Initials     | Cite No. | U.S. Patent Document No. | Name of Patentee or Applicant of Cited Document | Date of Publication of Cited Document MM-DD-YYYY |  |
|                       | 1. ✓     | 4,555,968                | Raney, et al.                                   | 12-03-1985                                       |  |
|                       | 2. ✓     | 4,524,582                | Lucas, et al.                                   | 06-25-1985                                       |  |
|                       | 3. ✓     | US2003/0070518           | Kurita, et al.                                  | 04-17-2003                                       |  |
|                       | 4. ✓     | 6,311,597                | Schroth, et al.                                 | 11-06-2001                                       |  |
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|                       | 10. ✓    | 5,568,766                | Otremba, et al.                                 | 10-29-1996                                       |  |
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| FOREIGN PATENT DOCUMENTS |             |                         |        |           |  |   |   |   |
|--------------------------|-------------|-------------------------|--------|-----------|--|---|---|---|
| Examiner<br>Initials     | Cite<br>No. | Foreign Patent Document |        |           | Name of Patentee or<br>Applicant of Cited Document | Date of<br>Publication of<br>Cited Document<br>MM-DD-YYYY | Pages, Columns, Lines, Where<br>Relevant Passages or Relevant<br>Figures Appear | T |
|                          |             | Office                  | Number | Kind Code |  |   |   |   |
|                          |             |                         |        |           |  |   |   |   |